

PCN # 2361N

DATE: March 13, 2023

EXPECTED PCN SHIP DATE: March 13, 2023



Quality Assurance
160 Rio Robles
San Jose, CA 95134

www.maximintegrated.com

PROCESS CHANGE NOTICE
 PRODUCT CHANGE NOTICE

ANALOG DEVICES HEREBY ISSUES NOTIFICATION OF CHANGE
THAT MAY AFFECT THE FOLLOWING CATEGORIES:

DESIGN WAFER FAB ASSEMBLY TEST ELEC/MECH SPECS

AFFECTED PRODUCT:

Ordering P/N: (See PN listing XLS in PCN ZIP file)

CHANGE FROM: -

Analog Devices products in current wafer fabrication process
S12 (6-inch wafer size) at ADI's Beaverton/Oregon foundry
(ADBN)

CHANGE TO: -

Move to process B12 (8-inch wafer size) at same ADI's
Beaverton/Oregon foundry (ADBN)

JUSTIFICATION: -

ADI is moving to the 8-inch B12 process to ensure adequate capacity for supply continuity.
ADI has achieved equivalency between the two processes.
ADI has been shipping products fabricated on the B12 Process in mass production from ADBN since 2009.
The wafer fabrication location remains the same.

B12 process reliability qualification report is attached (ref. R060002FQ_B12_Qual)

The Form/Fit/Function of the devices is unchanged.

TRACEABILITY: Analog Device maintains full traceability by device marking, packaging labels and shipment documents.

Analog Devices's Change Notification System is designed to keep our customer base apprised of major product, manufacturing, or facility improvements.

Nasser Ali Chaouche

Nasser AliChaouche / PCN Coordinator

For further information, please contact either of the people listed below.

Contact your local Analog Devices Company Representative or Nasser AliChaouche, PCN Coordinator
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